ISSUE: February 13,2018

TO;

	Product Name	PHOTOTRIAC COUPLE	<u> </u>
	Model No.	3SF21	
	(Business de	ealing name:PC3SF21YVZBH]
Th Af Sp	nis specification sheets a ter confirmation of the c pecifications with approv	n <u>14</u> pages including the cover and nd attached sheets shall be both signortents, please be sure to send backing signature on each. It is please contact us before issuing put	de copy. kcopy of the
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SHARP

- 1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp").

 Please handle with great cares and do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this Sharp product, please observe the absolute maximum ratings, other conditions and instructions for use described in the specification sheets, as well as the precautions mentioned below.
 Sharp assumes no responsibility for any damages resulting from use of the product which does not comply with absolute maximum ratings, other conditions and instructions for use included in the specification sheets, and the precautions

mentioned below.

(Precautions)

- (1) In making catalogue or instruction manual based on the specification sheets, please verify the validity of the catalogue or instruction manuals after assembling Sharp products in customer's products at the responsibility of customer.
- (2) This Sharp product is designed for use in the following application areas;
 - Computers OA equipment Telecommunication equipment (Terminal) Measuring equipment
 - Tooling machines Audio visual equipment Home appliances

If the use of the Sharp product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.

- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when Sharp product is used for equipment in responsibility of customer which demands high reliability and safety in function and precision, such as ;
 - Transportation control and safety equipment (aircraft, train, automobile etc.)
 - Traffic signals Gas leakage sensor breakers Rescue and security equipment
 - Other safety equipment
- (4) Sharp product is designed for consumer goods and controlled as consumer goods in production and quality.

 Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
 - Space equipment Telecommunication equipment (for trunk lines)
 - Nuclear power control equipment Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any question regarding interpretation of the above four paragraphs.
- 3. Disclaimer

The warranty period for Sharp product is one (1) year after shipment.

During the period, if there are any products problem, Sharp will repair (if applicable), replace or refund.

Except the above, both parties will discuss to cope with the problems.

The failed Sharp product after the above one (1) year period will be coped with by Sharp, provided that both parties shall discuss and determine on sharing responsibility based on the analysis results thereof subject to the above scope of warranty.

The warranty described herein is only for Sharp product itself which are purchased by or delivered to customer. Damages arising from Sharp product malfunction or failure shall be excepted.

Sharp will not be responsible for the Sharp product due to the malfunction or failures thereof which are caused by:

- (1) storage keep trouble during the inventory in the marketing channel.
- (2) intentional act, negligence or wrong/poor handling.
- (3) equipment which Sharp products are connected to or mounted in.
- (4) disassembling, reforming or changing Sharp products.
- (5) installation problem.
- (6) act of God or other disaster (natural disaster, fire, flood, etc.)
- (7) external factors (abnormal voltage, abnormal electromagnetic wave, fire, etc.)
- (8) special environment (factory, coastal areas, hotspring area, etc.)
- (9) phenomenon which cannot be foreseen based on the practical technologies at the time of shipment,
- (10) the factors not included in the product specification sheet.
- 4. Please contact and consult with a Sharp sales representative for any questions about Sharp product.

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1. Application

This specification applies to the outline and characteristics of lead free type phototriac coupler Model No. 3SF21 [Apply line voltage 200V AC(sine wave)].

2. Outline

Refer to the attached sheet, page 7.

Ratings and characteristics

Refer to the attached sheet, page 8, 9.

Reliability

Refer to the attached sheet, page 10.

Outgoing inspection

Refer to the attached sheet, page 11.

6. Supplement

6.1 Isolation voltage shall be measured in the following method.

- (1) Short between pins 1 to 3 on the primary side and between pins 4 to 6 on the secondary side.
- (2) The dielectric withstanding tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave. (It is recommended that the isolation voltage be measured in insulation oil.)
- 6.2 Packing specifications

Refer to the attached sheet, page 12, 13.

6.3 The relevant models are the models approved by VDE according to DIN EN 60747-5-5.

Approved Model No.: 3SF21

VDE approved No.: 40008189 (According to the specification DIN EN 60747-5-5)

Operating isolation voltage V_{IORM}

1140V (Peak)

Transient voltage

9000V (Peak)

Pollution

2

• Clearances distance (Between input and output):

8.0mm (MIN.)

• Creep age distance (Between input and output) :

Isolation thickness between input and output

8.0mm (MIN.) 0.4mm (MIN.)

Tracking-proof

CTI 175

· Safety limit values

Current (Isi) 200mA (Diode side)

Power (Psi)

400mW (Phototriac side)

Temperature (Tsi)

150°C

In order to keep safety electric isolation of phototriac coupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

Indication of VDE approval "

" is printed on minimum unit package.

Isolation specification according to EN 60747-5-5

Parameter		Condition	Rating	Unit	Remark
Class of environmental test		-	40/100/21	-	
Pollution		-	2	-	
Maximum operating isolation voltage		-	1140	V	Refer to
Partial discharge test voltage (Between input and output)					the Diagram 1
Diagram 1	V _m	t _m =10s, qc<5pC	1830	V	(3/13) Refer to
Diagram 2		$t_{st1}=1s, qc<5pC$	2140	V	the Diagram 2
Maximum over-voltage		t _{ini} =60s	9000	V	(4/13)
Safety maximum ratings					
1) Case temperature	Tsi	I _F =0, P _C =0	150	$^{\circ}\!\mathbb{C}$	Refer to
2) Input current	Isi	Pc=0	200	mA	the Fig. 1, 2 (4/13)
3) Electric power (Output or Total power dissipation)	Psi	-	400	mW	(,,13)
Isolation resistance (Test voltage between input and output; DC500V)		Tamb=Tsi	MIN.109		
		Tamb=100°C	MIN.10 ¹¹	Ω	
		Tamb 25℃	MIN.10 ¹²]	

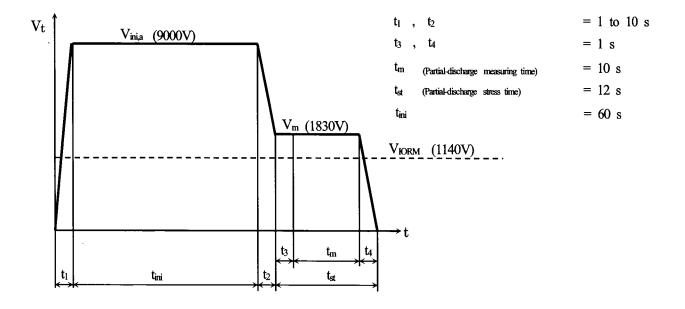
Precautions in performing isolation test

- (1) Partial discharge test methods shall be the ones according to the specifications of EN 60747-5-5
- (2) Please don't carry out isolation test (V_{iso}) over $V_{ini,a}$.

 This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. $V_{ini,a}$).

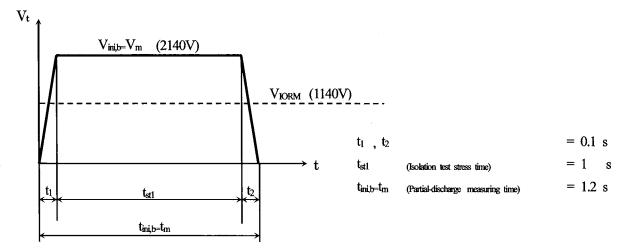
 And there is possibility that partial discharge occurs in operating isolation voltage. (V_{IORM}) .

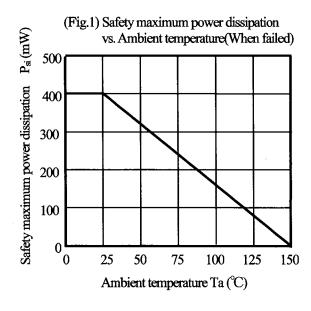
Method of Diagram 1: Breakdown test (Apply to type test and sampling test)

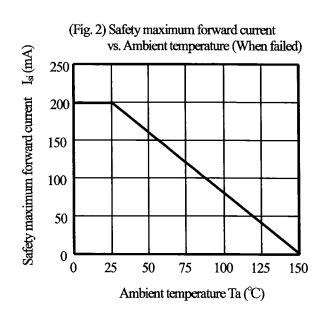


RESERVENCE

Method of Diagram 2: Non breakdown test (Apply to all device test)







6.4 This Model is approved by UL. Approved Model No.: 3SF21

UL file No.: E64380

6.5 This Model is approved by CSA.

Approved Model No.: 3SF21

CSA approved mark "

(1)

"shall be indicated on minimum unit package.

6.6 This product is approved by BSI, SEMKO, DEMKO and FIMKO.

6.7 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.8 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS: CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

- 6.9 Specified brominated flame retardants
 Specified brominated flame retardants (PBB and PBDE) are not used in this device at all.
- 6.10 Compliance with each regulation
 - The RoHS directive(2011/65/EU)
 This product complies with the RoHS directive(2011/65/EU).
 Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)
 - (2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese: 电子信息产品污染控制管理办法).

Marking Styles for the Names and Contents of the Hazardous Substances

			Hazan	dous Substances		
Category	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr ⁶⁺)	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)
Phototriac coupler	0	0	0	0	0	0

This table is prepared in accordance with the provisions of SJ/T 11364.

 $[\]bigcirc$: Indicates that said hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement of GB/T 26572

RESERVENCE

7. Notes

7.1 Cleaning

(1) Solvent cleaning: Solvent temperature 45°C or less, Immersion for 3 min or less

(2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size,

ultrasonic power output, cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition and confirm that any defect doesn't occur

before starting the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

7.2 Circuit design

- (1) The LED used in the Phototriac coupler generally decreases the light emission power by operation. In case of long operation time, please decide I_F value so that I_F is more than 2 times of the Maximum value of the Minimum triggering current at circuit design in consideration of the decreases of the light emission power of the LED. (50%/5years)
- (2) Input current (I_F) at off state shall be set 0.1mA or less.
- (3) In case that L (Inductance) load such as motor etc. is used, please use this device after confirming whether this device operates normally in actual condition since there is a case that the zero-cross circuit works and the load does not turn on due to the phase difference of load current.
- (4) If the voltage exceeding the repetitive peak off-state voltage (V_{DRM}) in the absolute maximum ratings is applied to the phototriac, it may cause not only faulty operation but breakdown. Make sure that the surge voltage exceeding V_{DRM} shall not be applied by using the varistor, the snubber circuit.

7.3 Precautions for Soldering Phototriac couplers

(1) In case of flow solder (Whole dipping is possible)

It is recommended that flow soldering be carried out at 270°C or less and within 10s

(Pre-heating: 100 to 150°C, 30 to 80s): Within 2 times

- (2) It is recommended that hand soldering be carried out at 400°C or less and within 3s; Within 2 times
- (3) Other notes

Depending on equipment and soldering conditions (temperature, Using solder etc.),

the effect to the device and the PCB is different.

Please confirm that there is no problem on the actual use conditions in advance.

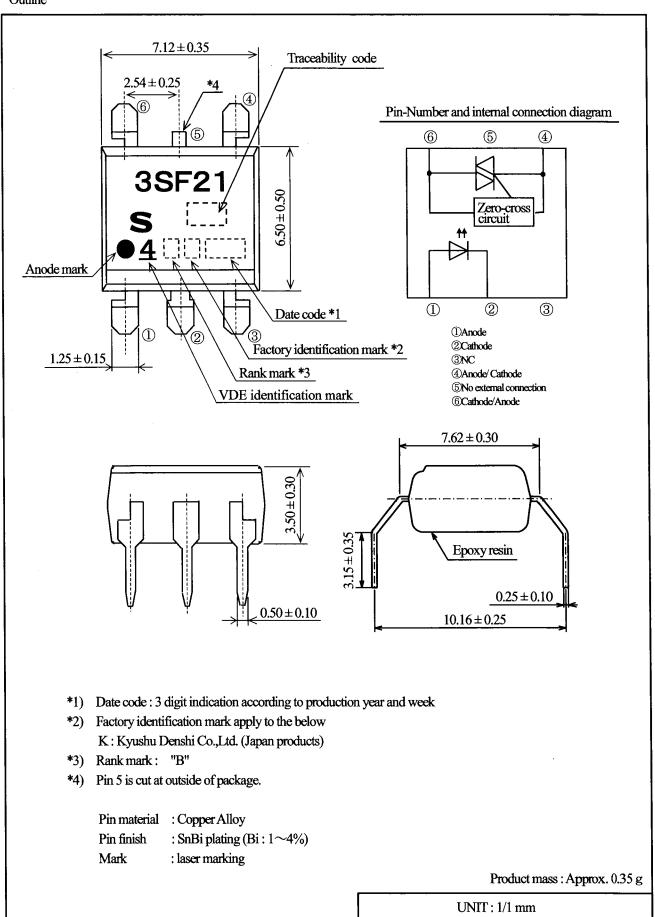
7.4 Usage

For triggering medium and high power triac.

(This model shall be used under the conditions on which power triac turns on.)

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2. Outline



Name

3SF21 Outline Dimensions

(Business dealing name: PC3SF21YVZBH)

3. Ratings and characteristics

3.1 Absolute maximum ratings

Ta=25°C

	Parameter	Symbol	Rating	Unit
Turnet	Forward current *1	I_{F}	50	mA
Input	Reverse voltage	V_R	6	V
	RMS on-state current *1	I _T (rms)	0.1	A
Output	Peak one cycle surge current	I _{surge}	1.2 (50Hz sine wave)	
	Repetitive peak off-state voltage	$V_{ m DRM}$	600	V
Isolation voltage *2		V _{iso} (rms)	5	kV
Operating temperature		Topr	-30 to +100	°C
Storage temperature		$T_{ m stg}$	-55 to +125	$^{\circ}$
	Soldering temperature T_{sol}		270 (For 10s)	°C

3.2 Electro-optical characteristics

Ta=25°C

							
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
T4	Forward voltage	V _F	I _F = 20mA	-	1.2	1.4	V
Input	Reverse current	I _R	$V_R = 3V$	-	-	10-5	Α
	Repetitive peak off-state current	I _{DRM}	$V_D = V_{DRM}$	-	-	10-6	A
	On-state voltage	V_{T}	$I_T = 0.1A$	-	-	2.5	V
Output	Holding current	I _H	$V_D=4V$	0.1	-	3.5	mA
	Critical rate of rise of off-state voltage	dv/dt	$V_D = 1/\sqrt{2} \cdot V_{DRM}$	1000	2000	-	V/μs
	Zero-cross voltage	Vox	I _F = 15mA, R load	-	_	20	V
	Minimum trigger current	I _{FT}	$V_D=4V, R_L=100\Omega$	-	-	7	mA
Transfer charac- teristics	Isolation resistance	R _{ISO}	DC500V 40 to 60%RH	5×10 ¹⁰	1011	_	Ω
	Turn on time	ton	$V_D = 4V, R_L = 100\Omega,$ $I_F = 20\text{mA}$	-		50	μs

^{*1} The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 3, 4.

^{*2} AC for 1 min, 40 to 60%RH, f=60Hz

REGSERVENICE

Fig.3 Forward current vs. Ambient temperature

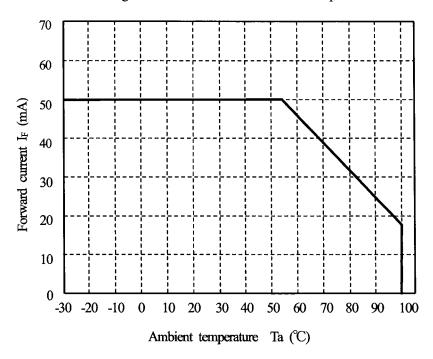
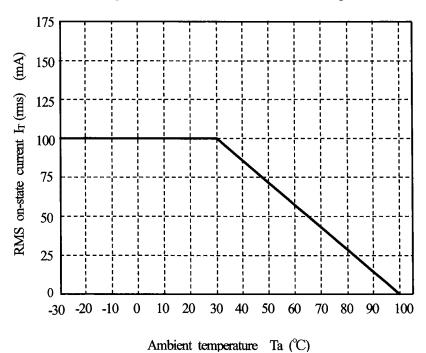


Fig.4 RMS on-state current vs. Ambient temperature





4. Reliability

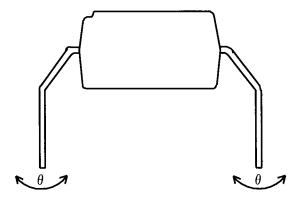
The reliability of products shall satisfy items listed below.

Confidence level: 90% LTPD: 10 or 20

_			7: 10 or 20
Test Items	Test Conditions *1	Failure Judgement Criteria	Samples (n) Defective(C)
Solderability	245±3°C, 5s	*2	n=11, C=0
G-1.1	(Flow soldering) 270°C, 10 s		11 C O
Soldering heat *3	(Soldering by hand) 400°C, 3 s		n=11,C=0
Terminal strength (Tension)	Weight: 5.0N 5 s/each terminal		n=11, C=0
Terminal strength (Bending) *4	Weight: 2.5N 2 times/each terminal	$V_F>U\times 1.2$	n=11, C=0
Mechanical shock	15km/s ² , 0.5ms 3 times/ \pm X, \pm Y, \pm Z direction	$V_T>U\times 1.2$	n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4min 200m/s ² 4 times/ X, Y, Z direction	$I_{FT}>U\times1.3$ $I_{R}>U\times2.0$	n=11, C=0
Temperature cycling	1 cycle -55°C to +125°C (30min) (30min) 20 cycles test Without Load	I _{DRM} >U×2.0 U: Upper specification limit	n=22,C=0
High temp. and high humidity storage	+85°C, 85%RH, 500h	L: Lower specification limit	n=22,C=0
High temp. storage	+125°C, 1000h		n=22,C=0
Low temp. storage	–55°C, 1000h		n=22,C=0
Operation life	I_F = 50mA, I_T = 100mA Ta = 25°C, 1000h		n=22,C=0

^{*1} Test method, conforms to EIAJ ED 4701.

- *3 Dip into the position of 1.0mm from the resin part.
- *4 Terminal bending direction is shown below.



**These test results are sampling examples from a specific lot for reference purpose only, and do not constitute any warranty or assurance in connection with the products.

^{*2} The product whose not-soldered area is more than 5% for all of the dipped area, and/or whose pinholes or voids are concentrated on one place shall be judged defect.

- 5. Outgoing inspection
 - 5.1 Inspection items
 - $\begin{array}{c} \text{(1)} \quad \text{Electrical characteristics} \\ \quad V_{\text{F}}, I_{\text{R}}, I_{\text{DRM}}, V_{\text{T}}, I_{\text{FT}}, R_{\text{ISO}}, V_{\text{iso}} \end{array}$
 - (2) Appearance
 - 5.2 Sampling method and Inspection level

LTPD sampling inspec	ction	Confidence level: 90%
Defect Inspection item		LTPD (%)
Major defect	Electrical characteristics(faiure) Marking (Unreadable) Lead form (Deformation)	3
Minor defect	Appearance defect except the above mentioned.	50

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6.2 Packing specification

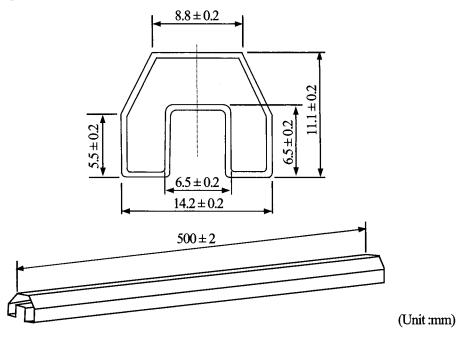
6.2.1 Package materials

No.	Name	Materials	Purposes
1	Sleeve	PS or PC with preventing static electricity	Products packaged
2	Stopper	Enhanced polymer	Products fixed
3	Inner bag	Polyethylene	Packaging bag for sleeve with product
4	Sealing tape	Cellophane	Lid of inner bag
5	Label	Paper	Model No., (Business dealing name), Lot No., Quantity, Country of origin, Company name and Inspection date specified
6	Packing case	Paper	Inner bag packaged
7	Cushioning material	Polyethylene	Inner bag fixed
8	Sealing tape	Cellophane	Lid of packingcase
9	Label	Paper	Model No., (Business dealing name), Lot No., Quantity, Country of origin, Company name and Inspection date specified

6.2.2 Package method

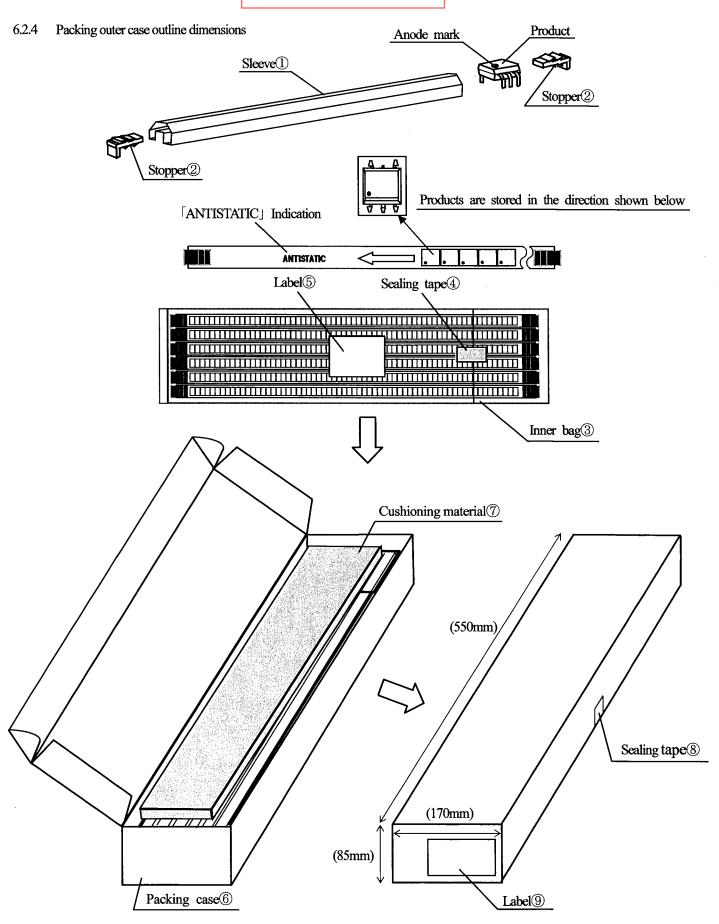
- (1) MAX. 60pcs. of products shall be packaged in a sleeve ① and both of sleeve edges shall be fixed by stoppers ②.
- (2) MAX. 25 sleeves (Product: 1500pcs.) above shall be packaged in inner case 3. and sealed by tape 4.
- (3) The label (5) shall be put on the top of the inner bag.
- (4) Max 2 bags(product: 3000pcs) above shall be packaged in packing case (6), and put a cushioning material (7) inside.
- (5) The label (9) shall be put on the side of the packing case.
- (6) Case shall be closed with the lid and enclosed with kraft tape (8).

6.2.3 Sleeve package ① outline dimensions



- Note 1) Thickness: 0.5 ± 0.2 mm
 - 2) Process with applying antistatic treatment.
 - 3) Unless otherwise specified tolerances shall be ± 0.5 mm. (However except for deformation due to the stopper in sleeve.)

REPERENTE



Regular packing mass: Approx. 2.2kg

(): Reference dimensions

Storage condition

Packaged products shall be stored at the temperature 5 to 30° C and the humidity 70%RH or less away from direct sunlight.